

#### **Features**

- Peak Output Current: IOP = ±2.5A (max)
- Threshold Input Current: IFLH = 5 mA (max)
- Common mode transient immunity: ±25kV/µs (min)
- Under voltage lock out (UVLO) protection with hysteresis
- RoHS and REACH Compliance
- MSL class 1
- Regulatory Approvals
  - ✓ UL UL1577 (E364000)
  - ✓ VDE EN60747-5-5(VDE0884-5)
  - ✓ CQC GB4943.1, GB8898(14001104999)
  - ✓ IEC62368 (FI/41119)

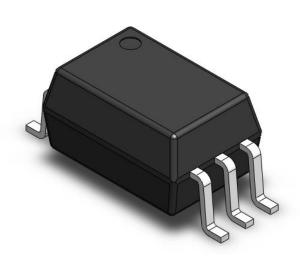
#### **Description**

The CTS700 consists of a LED optically coupled to an integrated circuit with a power output stage. This optocoupler is ideally suited for driving power IGBTs and MOSFETs used in motor control inverter applications. The high operating voltage range of the output stage provides the drive voltages required by gate-controlled devices.

#### **Applications**

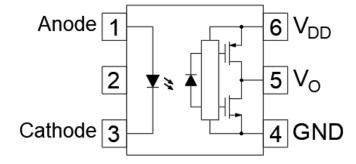
- Isolated IGBT/Power MOSFET gate drive
- Industrial Inverter
- AC brushless and DC motor drives
- Induction Heating

#### **Package Outline**



Note: Different lead forming options available. See package dimension.

#### **Schematic**



#### **Truth Table**

LED	V <sub>CC</sub> -V <sub>EE</sub> Positive Going	V <sub>cc</sub> -V <sub>EE</sub> Negative Going	Output
Off	0 to 30 V	0 to 30V	Low
On	0 to 11.0V	0 to 9.5V	Low
On	11.0 to 13.5V	9.5 to 12V	Transition
On	13.5 to 30V	12 to 30V	High



#### Absolute Maximum Ratings $T_A = 25^{\circ}C$ , unless otherwise specified

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage (AC, 1 minute, 40 ~ 60% R.H.)	5000	V <sub>RMS</sub>	1
Topr	Operating temperature	-40 ~ +110	°C	
Tstg	Storage temperature	-55 ~ +125	°C	
Tsol	Soldering temperature (For 10 seconds)	260	°C	2
PT	Total Power Dissipation	300	mW	
Emitter				
I <sub>F</sub>	Forward current	25	mA	
I <sub>FP</sub>	Peak forward current (50% duty, 1ms P.W)	1	А	
V <sub>R</sub>	Reverse voltage	5	V	
Detector				
P <sub>D</sub>	Power dissipation	250	mW	
V <sub>O(PEAK)</sub>	Peak Output Voltage	0 to 30	V	3
Іорн	Output High Peak Current	2.5	А	4
IOPL	Output Low Peak Current	2.5	А	4
Vcc	Supply voltage	0 to 30	V	

#### Notes

- 1. AC for 1 minute,  $RH = 40 \sim 60\%$ .
- 2. For 10 second peak
- 3. The  $V_{O(PEAK)}$  voltage CAN NOT BE high than  $V_{CC}$ .
- 4. The  $I_0$  maximum pulse width = 10  $\mu$ s, maximum duty cycle = 0.2%.



#### **Electrical Characteristics**

Over recommended operating conditions TA = -40 to 110 °C.

Typical values are measured at  $V_{CC}$ =30V,  $V_{EE}$ = GND,  $T_A$ = 25°C (unless otherwise stated)

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 10mA	-	1.45	1.8	V	
VR	Reverse Voltage	IR = 10μA	5.0	-	-	V	
$\Delta V_F/\Delta T_A$	Temperature coefficient of forward voltage	IF =10mA	-	-1.8	-	mV/°C	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
ICCL	Logic Low Supply Current	V <sub>F</sub> = 0 to 0.8V, V <sub>O</sub> = Open	-	1.5	5	mA	
Іссн	Logic High Supply Current	I <sub>F</sub> = 7mA to 10mA, V <sub>O</sub> = Open	-	1.5	5	MA	

#### **Transfer Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
V	High Land Outrast Value	I <sub>F</sub> = 10mA, I <sub>O</sub> = -2.5A	Vcc - 6	-	-	.,	
V <sub>OH</sub>	High Level Output Voltage	I <sub>F</sub> = 10mA, I <sub>O</sub> = -100mA	V <sub>CC</sub> - 4	-	-	V	
.,		I <sub>F</sub> = 0mA, I <sub>O</sub> = 2.5A	-	-	V <sub>EE</sub> + 6	.,	
V <sub>OL</sub>	Low Level Output Voltage	I <sub>F</sub> = 0mA, I <sub>O</sub> = 100mA	-	-	V <sub>EE</sub> + 4	V	
Іорн	High Level Output Current	V <sub>O</sub> = V <sub>CC</sub> -3V	-	-	-1	A	1
		Vo= Vcc-6V	-	-	-2		1
		Vo= VEE+3V	1	-	-		1
I <sub>OPL</sub>	Low Level Output Current	Vo= VEE+6V	2	-	-	Α	1
I <sub>FLH</sub>	Input Threshold Current	I <sub>O</sub> = 0mA, V <sub>O</sub> > 5V	-	1.4	5.0	mA	
V <sub>FHL</sub>	Input Threshold Voltage	I <sub>O</sub> = 0mA, V <sub>O</sub> < 5V	0.8	-	-	V	
V <sub>UVLO+</sub>	Under Voltage Lockout	I <sub>O</sub> = 10mA, V <sub>O</sub> > 5V	11	-	13.5	M	
V <sub>UVLO</sub> -	Threshold	Io= 10mA, Vo< 5V	9.5	-	12.0	V	

#### Notes

1. The  $I_0$  maximum pulse width = 10  $\mu$ s, maximum duty cycle = 0.2%.



#### **Electrical Characteristics**

Over recommended operating conditions TA = -40 to 110 °C.

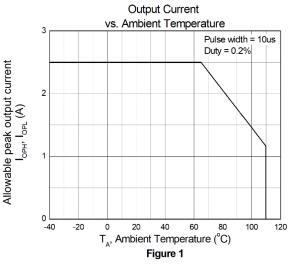
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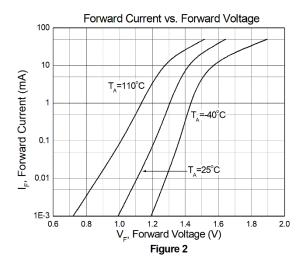
#### **Switching Characteristics**

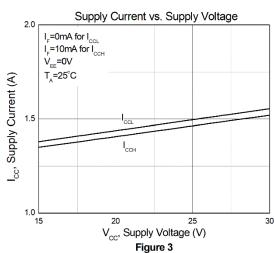
Symbol	Parameters	Test C	onditions	Min	Тур	Max	Units	Notes
T <sub>PHL</sub>	High to Low Propagation Delay			100	180	500	ns	
T <sub>PLH</sub>	Low to High Propagation Delay	1 7 to 10 to 1	. C. 40=E D	100	140	500	ns	
P <sub>WD</sub>	Pulse Width Distortion		A, C <sub>L</sub> = 10nF, R <sub>L</sub> =		40	300	ns	
tpsk	Propagation Delay Skew	$-$ 10Ω, f= 10kHz, Duty = 50%, $-$ T <sub>A</sub> = 25 $^{\circ}$ C				40	ns	
t <sub>r</sub>	Rise Time				20		ns	
t <sub>f</sub>	Fall Time				20		ns	
tuvlo(on)	UVLO Turn On Delay	I <sub>F</sub> = 10mA, V <sub>O</sub>	> 5V		3.5		μs	
tuvlo(off)	UVLO Turn Off Delay	I <sub>F</sub> = 10mA, V <sub>O</sub>	< 5V		3		μs	
CM <sub>H</sub>	Common Mode Transient High	$V_{CC}=30V$ , $T_{A}=25$ $^{0}C$ ,	I <sub>F</sub> = 7 to 16mA	25			kV/μs	
CM <sub>L</sub>	Common Mode Transient Low	V <sub>CM</sub> = 1.5kV	I <sub>F</sub> = 0mA	25			kV/μs	

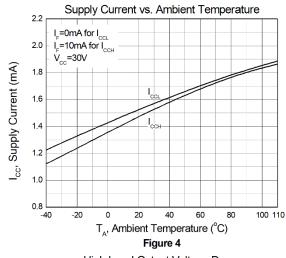


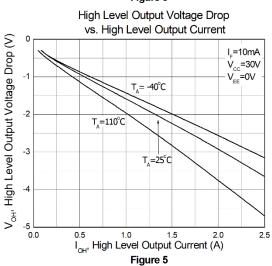
#### Typical Characteristic Curves $T_A = 25$ °C, unless otherwise specified

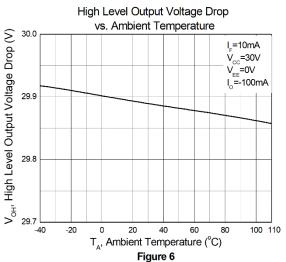






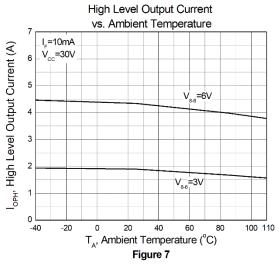


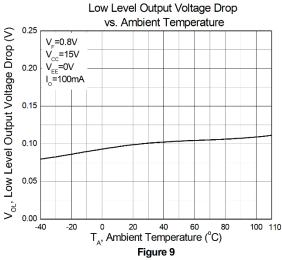


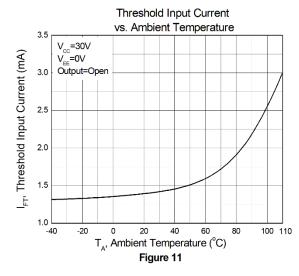


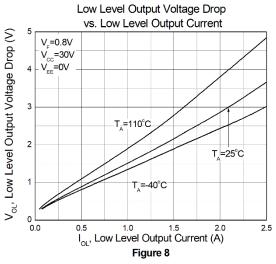


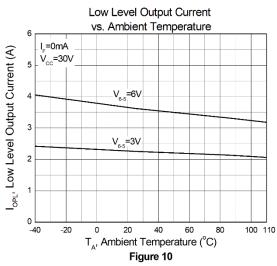
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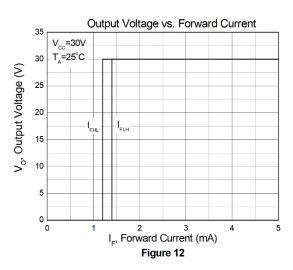








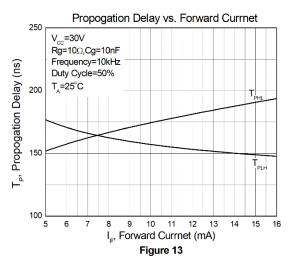


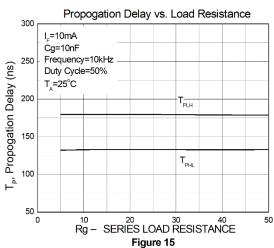


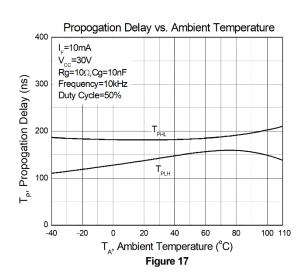
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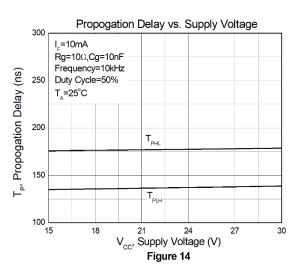


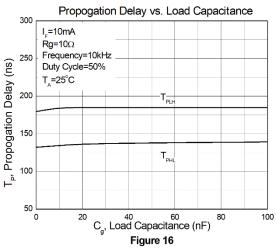
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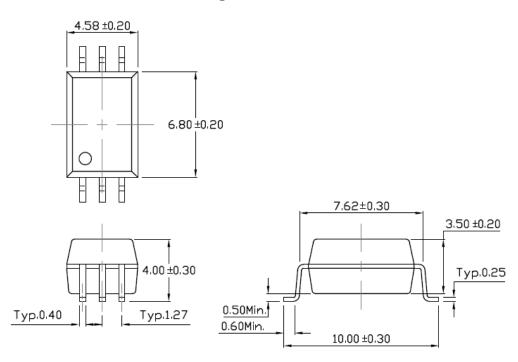




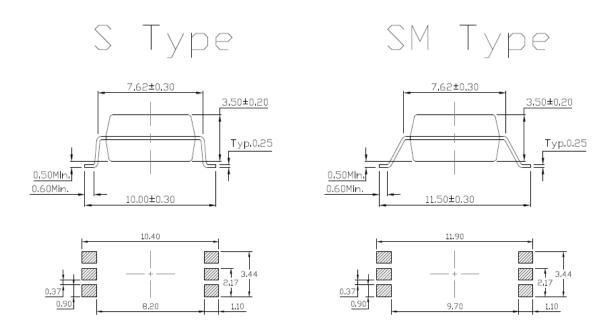


#### Package Dimension Dimensions in mm unless otherwise stated

#### **Surface Mount Lead Forming**



#### Forming Option Dimensions in mm unless otherwise stated





#### **Marking Information**



#### Note:

CT : Denotes "CT Micro"

700 : Part Number

V : VDE Safety Mark Option (Blank or V)

Y : One Digit Year CodeWW : Two Digit Work WeekK : Manufacturing Code

#### **Ordering Information**

# CTS700(V)(Y)(Z)

CT = Denotes "CT Micro"

S700 = Part Number

V = VDE Safety Mark Option (Blank or V)

Y = Lead Form Option (S or SM)

Z = Tape and Reel Option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming with Option 1 Taping	1500 Units/Reel
T2	Surface Mount Lead Forming with Option 2 Taping	1500 Units/Reel
M(T1)	Surface Mount (Gullwing) Lead Forming with Option 1 Taping	1500 Units/Reel
M(T2)	Surface Mount (Gullwing) Lead Forming with Option 2 Taping	1500 Units/Reel

#### Reel Dimension All dimensions are in mm, unless otherwise stated

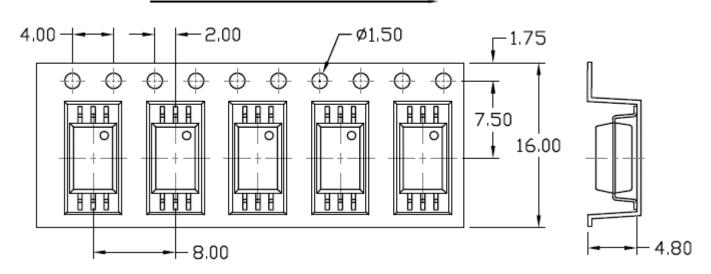
# Option S(T1/T2) Option M(T1/T2) 100.00 330.00 100.00 330.00 -16.50 -24.50 -28.50



#### Carrier Tape Specifications Dimensions in mm unless otherwise stated

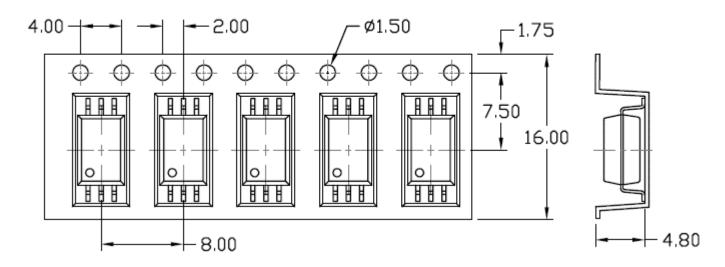
#### Option S(T1)

# Input Direction



#### Option S(T2)

# Input Direction

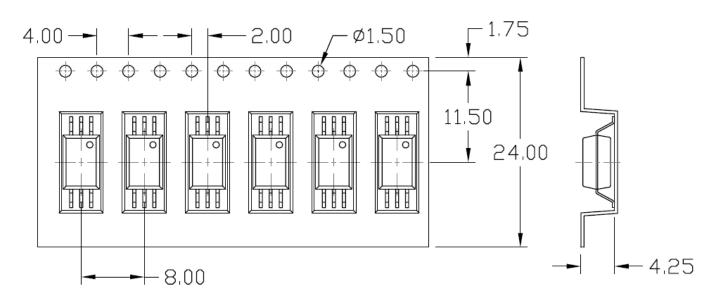






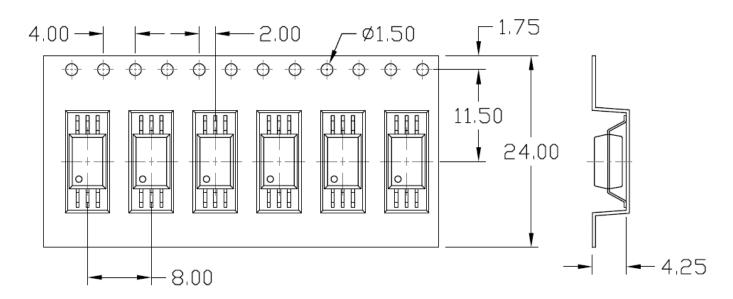
#### **Option SM(T1)**

# Input Direction



#### Option SM(T2)

# Input Direction





#### Solderability spec (Follow the JEDEC standard JESD22-B102)

Reflow Soldering: Immersed surface, other than the end of pin as cut-surface, must be covered by solder.

Solder-Bath: More than 95% of the electrode must be covered with solder.

#### **Wave soldering (Follow the JEDEC standard JESD22-A111)**

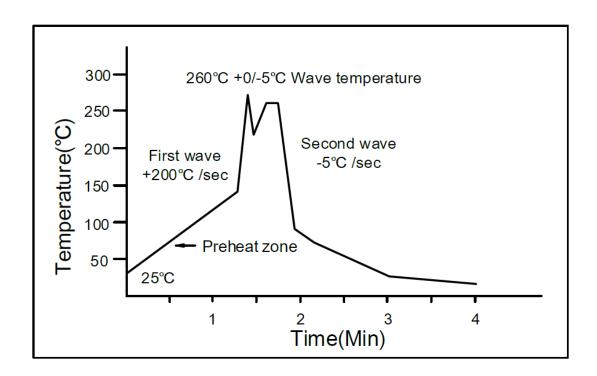
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature: 25 to 140°C.

Preheat time: 30 to 80 sec.



#### Iron soldering (Follow the standard MIL-STD 202G, Method 210F)

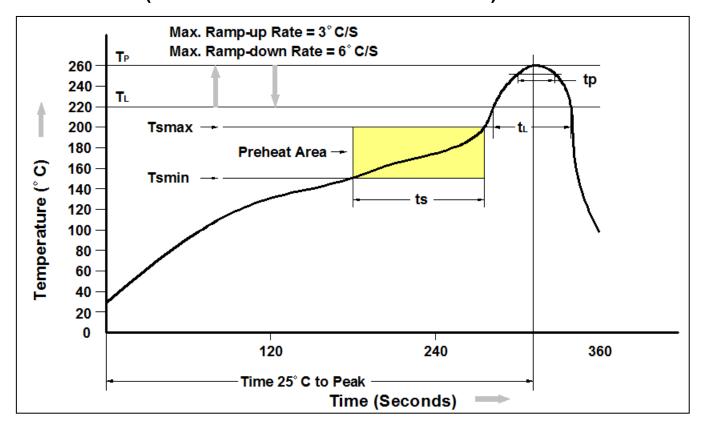
Allow single lead soldering in every single process.

One time soldering is recommended. Temperature: 350±10°C

Time: 5 sec max.



#### Reflow Profile (Follow the JEDEC standard J-STD-020)



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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#### 2.5A MOSFET/IGBT Gate Driver Optocoupler

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